



Doc.No.: AFY240320A0-2.8N6NTM

REV : A0

PAGE : 1/21

EFFECTIVE DATE : 2013-07-05

# SPECIFICATION OF LCD MODULE

MODULE NO.: AFY240320A0-2.8N6NTM

Customer Approval:

Accept

Reject

FUTURE FOCUS	SIGNATURE	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		



Doc.No.: AFY240320A0-2.8N6NTM

REV : A0

PAGE : 2/21

EFFECTIVE DATE : 2013-07-05

Sample Version	Doc. Version	DATE	DESCRIPTION	CHECKED BY
0001	A0	2013-07-05	First Release	

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## NUMBER SYSTEM INTRODUCTION:

AFY240320A0-2.8N6NTM:

AF: Orient Display TFT;

Y: JAZZ TFT;

240320: Length \* width pixel;

A0: Product Version;

2.8: Diagonal Dimension;

N: LCD Mode (N: TN; I: IPS; V: VA)

6: Viewing Direction (6-> 6:00; 12->12:00; Unavailable for IPS and VA);

M: Temperature Range (N: Normal; W: Wide);

T: Polarizer (T:Transmissive; F:Transflective);

N: Luminance (N: Normal <300 nit; M: Middle >=300 & <600 nit;

H: High >=600 nit);

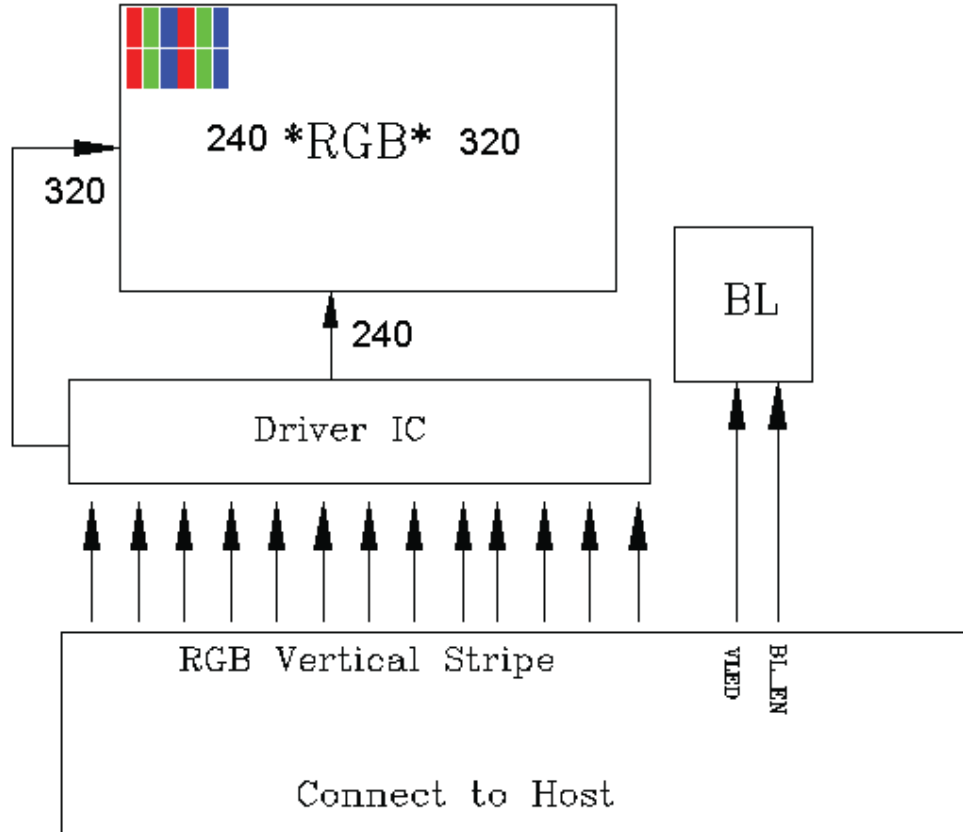
R: TP Option (R: Resistive TP; C: Capacitive TP; N: Without TP);

## 1. GENERAL SPECIFICATIONS

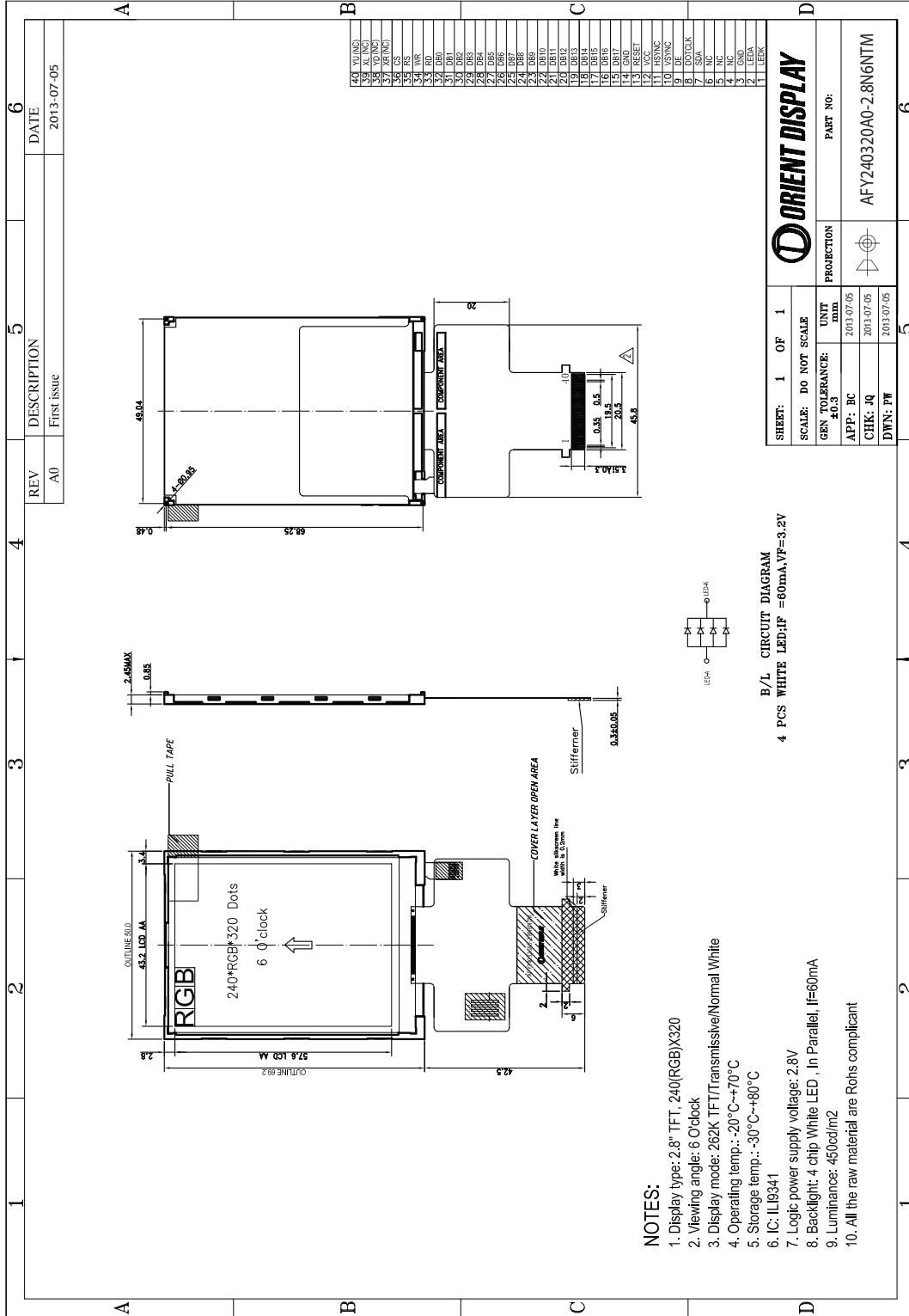
ITEM	SPECIFICATION	UNIT
OUTLINE DIMENSIONS	50(W) X69.2 (H) X2.45 (D)	mm
DISPLAY SIZE	2.8	inch
DOT PITCH	0.18mmX0.18mm	mm
NUMBER OF DOTS	240* (RGB) *320	-
DRIVER IC	ILI9341	-
LCD TYPE	TFT(262K) TRANSMISSIVE	-
INTERFACE	MCU 18 BITS	
BACKLIGHT TYPE	LED White	-
VIEWING DIRECTION	6 O'clock	-
GRAY SCALE INVERSION DIRECTION	12 O'clock	

\*See attached drawing for details.

## 2. BLOCK DIAGRAM



### 3. DIMENSIONAL OUTLINE



**NOTES:**

1. Display type: 2.8" TFT, 240(RGB)X320
2. Viewing angle: 6 O'clock
3. Display mode: 262K TFT/Transmissive/Normal White
4. Operating temp.: -20°C--+70°C
5. Storage temp.: -30°C--+80°C
6. IC: ILI6341
7. Logic power supply voltage: 2.8V
8. Backlight: 4 chip White LED , in Parallel, I=60mA
9. Luminance: 450cd/m<sup>2</sup>
10. All the raw material are Rohs complicant

ORIENT DISPLAY		PART NO:	
PROJECTION	AFY240320A0-2.8N6NTM	UNIT	mm
SCALE: DO NOT SCALE	±0.3	APP: BC	2013-07-05
GEN TOLERANCE:		CHK: JQ	2013-07-05
		DWN: PW	2013-07-05

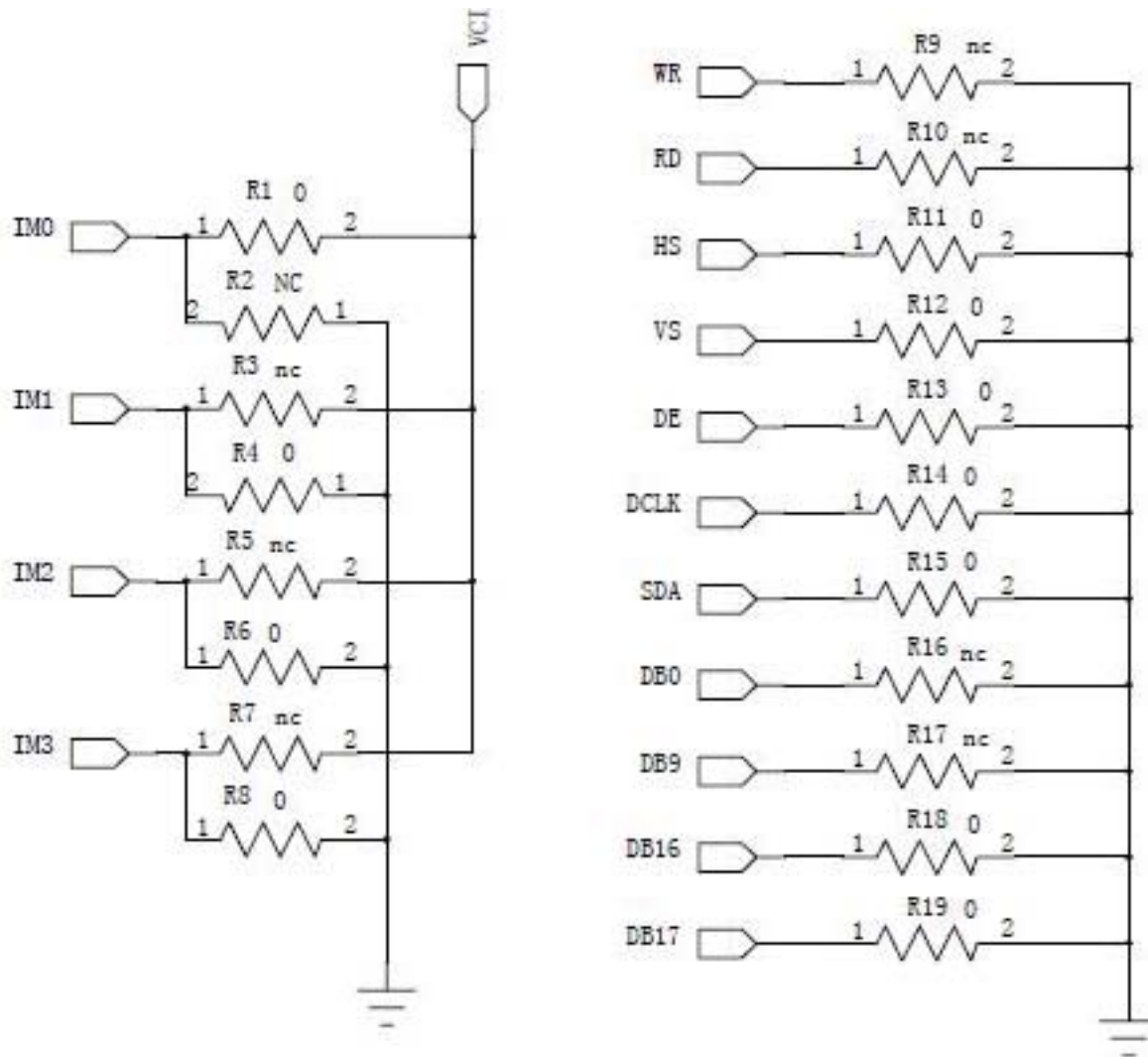
40	VLING
39	VLING
38	VLING
37	ART(NC)
36	CS
35	RS
34	RS
33	RD
32	DB0
31	DB1
30	DB2
29	DB3
28	DB4
27	DB5
26	DB6
25	DB7
24	DB8
23	DB9
22	DB10
21	DB11
20	DB12
19	DB13
18	DB14
17	DB15
16	DB16
15	DB17
14	DB18
13	DB19
12	VCC
11	RSYNC
10	RSYNC
9	DOTCLK
8	DOTCLK
7	SDA
6	NC
5	NC
4	NC
3	GND
2	LED
1	LED

#### 4. PIN DESCRIPTION:

NO.	PIN NAME	Type	Description																																																																															
1	LEDK	P	Power supply for LED (Cathode)																																																																															
2	LEDA	P	Power supply for LED (Anode)																																																																															
3	GND	P	Ground(0V)																																																																															
4~6	NC	-	No connection																																																																															
7	SDA	I/O	SPI Serial Data Input/output																																																																															
8	DOTCLK	I	Pixel clock signal																																																																															
9	DE	I	Data enable																																																																															
10	VSYNC	I	Vertical synchronizing signal																																																																															
11	HSYNC	I	Horizontal synchronizing signal																																																																															
12	VCC	P	Power voltage																																																																															
13	RESET	I	Reset signal																																																																															
14	GND	P	Ground(0V)																																																																															
15-32	DB17-DB0	I/O	Data bus - Select the MCU interface mode <table border="1" data-bbox="800 894 1386 1423"> <thead> <tr> <th rowspan="2">IM3</th> <th rowspan="2">IM2</th> <th rowspan="2">IM1</th> <th rowspan="2">IM0</th> <th rowspan="2">MCU-Interface Mode</th> <th colspan="2">DB Pin in use</th> </tr> <tr> <th>Register/Content</th> <th>GRAM</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>80 MCU 8-bit bus interface I</td> <td>D[7:0]</td> <td>D[7:0]</td> </tr> <tr> <td>0</td> <td>0</td> <td>0</td> <td>1</td> <td>80 MCU 16-bit bus interface I</td> <td>D[7:0]</td> <td>D[15:0]</td> </tr> <tr> <td>0</td> <td>0</td> <td>1</td> <td>0</td> <td>80 MCU 9-bit bus interface I</td> <td>D[7:0]</td> <td>D[8:0]</td> </tr> <tr> <td>0</td> <td>0</td> <td>1</td> <td>1</td> <td>80 MCU 18-bit bus interface I</td> <td>D[7:0]</td> <td>D[17:0]</td> </tr> <tr> <td>0</td> <td>1</td> <td>0</td> <td>1</td> <td>3-wire 9-bit data serial interface I</td> <td colspan="2">SDA: In/OUT</td> </tr> <tr> <td>0</td> <td>1</td> <td>1</td> <td>0</td> <td>4-wire 8-bit data serial interface I</td> <td colspan="2">SDA: In/OUT</td> </tr> <tr> <td>1</td> <td>0</td> <td>0</td> <td>0</td> <td>80 MCU 16-bit bus interface II</td> <td>D[8:1]</td> <td>D[17:10], D[8:1]</td> </tr> <tr> <td>1</td> <td>0</td> <td>0</td> <td>1</td> <td>80 MCU 8-bit bus interface II</td> <td>D[17:10]</td> <td>D[17:10]</td> </tr> <tr> <td>1</td> <td>0</td> <td>1</td> <td>0</td> <td>80 MCU 18-bit bus interface II</td> <td>D[8:1]</td> <td>D[17:0]</td> </tr> <tr> <td>1</td> <td>0</td> <td>1</td> <td>1</td> <td>80 MCU 9-bit bus interface II</td> <td>D[17:10]</td> <td>D[17:9]</td> </tr> </tbody> </table>	IM3	IM2	IM1	IM0	MCU-Interface Mode	DB Pin in use		Register/Content	GRAM	0	0	0	0	80 MCU 8-bit bus interface I	D[7:0]	D[7:0]	0	0	0	1	80 MCU 16-bit bus interface I	D[7:0]	D[15:0]	0	0	1	0	80 MCU 9-bit bus interface I	D[7:0]	D[8:0]	0	0	1	1	80 MCU 18-bit bus interface I	D[7:0]	D[17:0]	0	1	0	1	3-wire 9-bit data serial interface I	SDA: In/OUT		0	1	1	0	4-wire 8-bit data serial interface I	SDA: In/OUT		1	0	0	0	80 MCU 16-bit bus interface II	D[8:1]	D[17:10], D[8:1]	1	0	0	1	80 MCU 8-bit bus interface II	D[17:10]	D[17:10]	1	0	1	0	80 MCU 18-bit bus interface II	D[8:1]	D[17:0]	1	0	1	1	80 MCU 9-bit bus interface II	D[17:10]	D[17:9]
			IM3						IM2	IM1	IM0	MCU-Interface Mode	DB Pin in use																																																																					
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			0	1	0	1	3-wire 9-bit data serial interface I	SDA: In/OUT																																																																										
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			1	0	1	0	80 MCU 18-bit bus interface II	D[8:1]	D[17:0]																																																																									
			1	0	1	1	80 MCU 9-bit bus interface II	D[17:10]	D[17:9]																																																																									
			33	RD	I	Read signal, active at low in MCU mode; In SPI mode, connect to GND																																																																												
			34	WR	I	Write Signal, active at low in MCU mode; In SPI mode, SPI Serial Clock																																																																												
35	RS	I	In MCU mode, Register select signal, low is selected data register; High is selected command register. In SPI mode, connect to GND																																																																															
36	CS	I	Chip selection pin/ Serial port data enable signal																																																																															
37	XR(NC)	-	No connection																																																																															
38	YD(NC)	-	No connection																																																																															
39	XL(NC)	-	No connection																																																																															
40	YU(NC)	-	No connection																																																																															

Note: 1: input, 0: output, P: Power

Note: 2: Default interface of this part is "80 MCU 16-bit bus interface I" ([IM3:IM0] =0001), and "HS", "VS", "DE", "DCLK", "SDA", "DB16", "DB17", already are connected to GND via 0 ohm resistor on FPC. Refer to below circuit.





## 5. ELECTRICAL CHARACTERISTICS

### 5.1 Absolute Maximum Ratings

Item	Symbol	Values		Unit	Remark
		Min	Max		
Power Supply for Pump	VCC	-0.3	4.5	V	
Operating temperature range	To	-20	70	Degree C	
Storage temperature range	Ts	-30	80	Degree C	
Logic input voltage range	VI	-0.3	VCC+0.3	V	
Logic input voltage range	VO	-0.3	VCC+0.3	V	

Note: Stresses beyond those given in the Absolute Maximum Rating table may cause operational errors or damage to the device. For normal operational conditions see AC/DC Electrical Characteristics

### 5.2 DC Characteristics

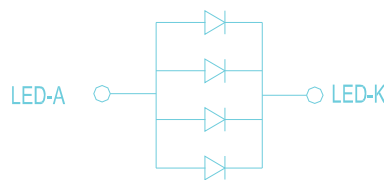
Item	Symbol	Values			Unit	Conditions
		Min	Typ	Max		
Low Level Input Voltage	Vil	GND	-	0.3xVCC	v	
High Level Input Voltage	Vih	0.7xVCC	-	VCC	uA	
High Level Output Voltage	Voh	VCC-0.4	-	VCC	ohm	
Low Level Output Voltage	Vol	GND	-	GND+0.4	uA	
Power Supply	VCC	2.5	2.8	3.3	V	
Input Leakage Current	Iil			±1.0	uA	
Pull High/Low Resistor	Rp	-	100K	-	ohm	

### 5.3 DC BackLight Unit

Item	Symbol	Min	Typ	Max	Unit	Remark
Average luminous Intensity	lv		450		cd/m2	IF=60mA
Chromaticity Coordinates	X	0.234	0.284	0.334		IF=60mA
	Y	0.273	0.323	0.373		IF=60mA
Forward Voltage	VF		3.2	3.4	V	IF=60mA
Reverse Current	IR			50	$\mu$ A	VR=5V,1LED
Luminous Tolerance	IV-M	80			%	(MIN/MAX) $\times$ 100
Power Dissipation	Pd	192			mW	
Peak Forward Current	lfp	100			$\mu$ A	
Reverse Voltage	VR	5			V	

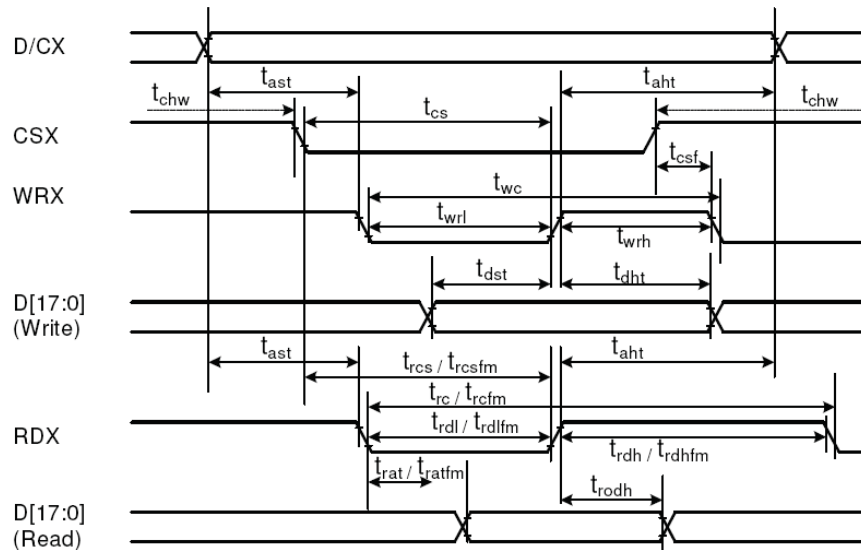
## B/L CIRCUIT DIAGRAM

4 PCS WHITE LED;IF =60mA,VF=3.2V



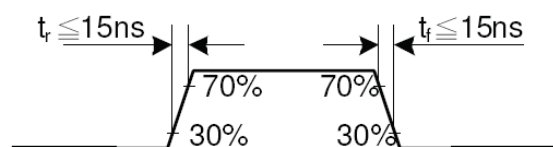
## 6. INPUT SIGNAL TIMING

### 6.1 Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080- I system)

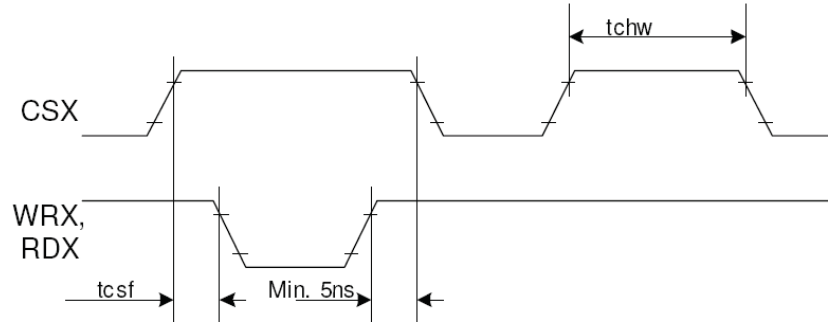


Signal	Symbol	Parameter	min	max	Unit	Description
DCX	tast	Address setup time	0	-	ns	
	taht	Address hold time (Write/Read)	0	-	ns	
CSX	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
WRX	twc	Write cycle	66	-	ns	
	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
RDX (FM)	trcfm	Read Cycle (FM)	450	-	ns	
	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
RDX (ID)	trc	Read cycle (ID)	160	-	ns	
	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D[17:0], D[15:0], D[8:0], D[7:0]	tdst	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

Note:  $T_a = -30$  to  $70$  °C,  $V_{DDI} = 1.65V$  to  $3.3V$ ,  $V_{CI} = 2.5V$  to  $3.3V$ ,  $V_{SS} = 0V$

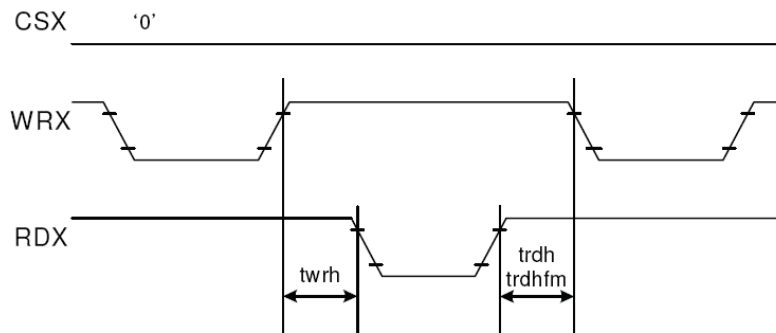


CSX timings :



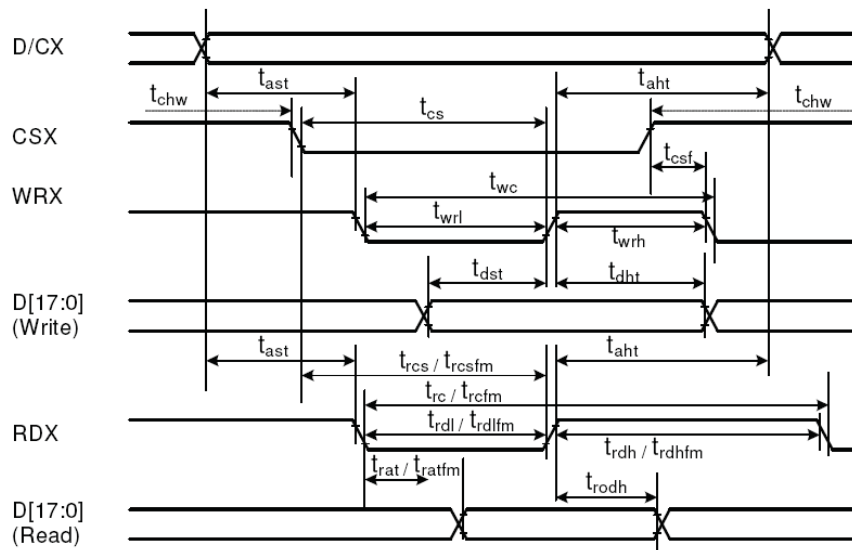
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:



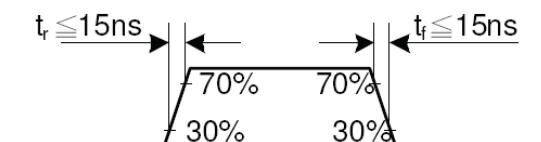
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

## 6.2 Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080- II system)

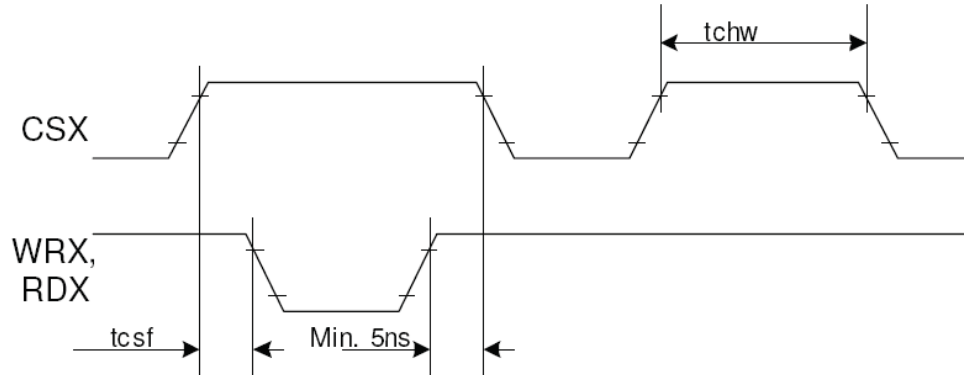


Signal	Symbol	Parameter	min	max	Unit	Description
DCX	tast	Address setup time	0	-	ns	
	taht	Address hold time (Write/Read)	0	-	ns	
CSX	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
WRX	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
	twc	Write cycle	66	-	ns	
	twrh	Write Control pulse H duration	15	-	ns	
RDX (FM)	twrl	Write Control pulse L duration	15	-	ns	
	trcfm	Read Cycle (FM)	450	-	ns	
	trdhfm	Read Control H duration (FM)	90	-	ns	
RDX (ID)	trdlfm	Read Control L duration (FM)	355	-	ns	
	trc	Read cycle (ID)	160	-	ns	
	trdh	Read Control pulse H duration	90	-	ns	
D[17:0], D[17:10]&D[8:1], D[17:10], D[17:9]	trdl	Read Control pulse L duration	45	-	ns	
	tdst	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
trodh	Read output disable time	20	80	ns		

Note:  $T_a = -30$  to  $70$  °C,  $V_{DDI}=1.65V$  to  $3.3V$ ,  $V_{CI}=2.5V$  to  $3.3V$ ,  $V_{SS}=0V$ .

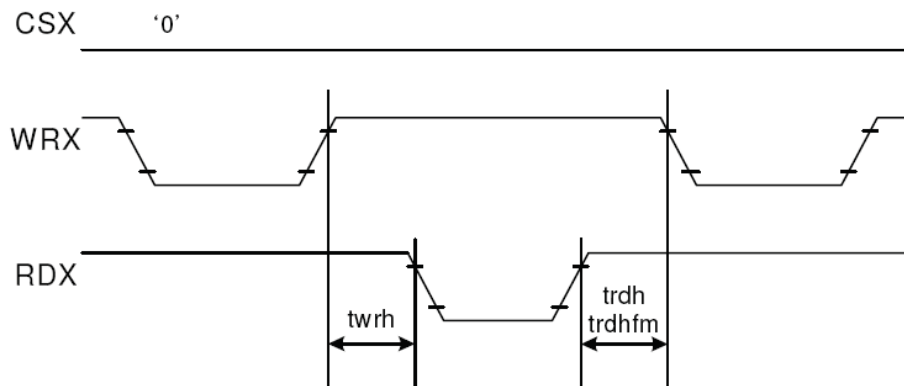


CSX timings :



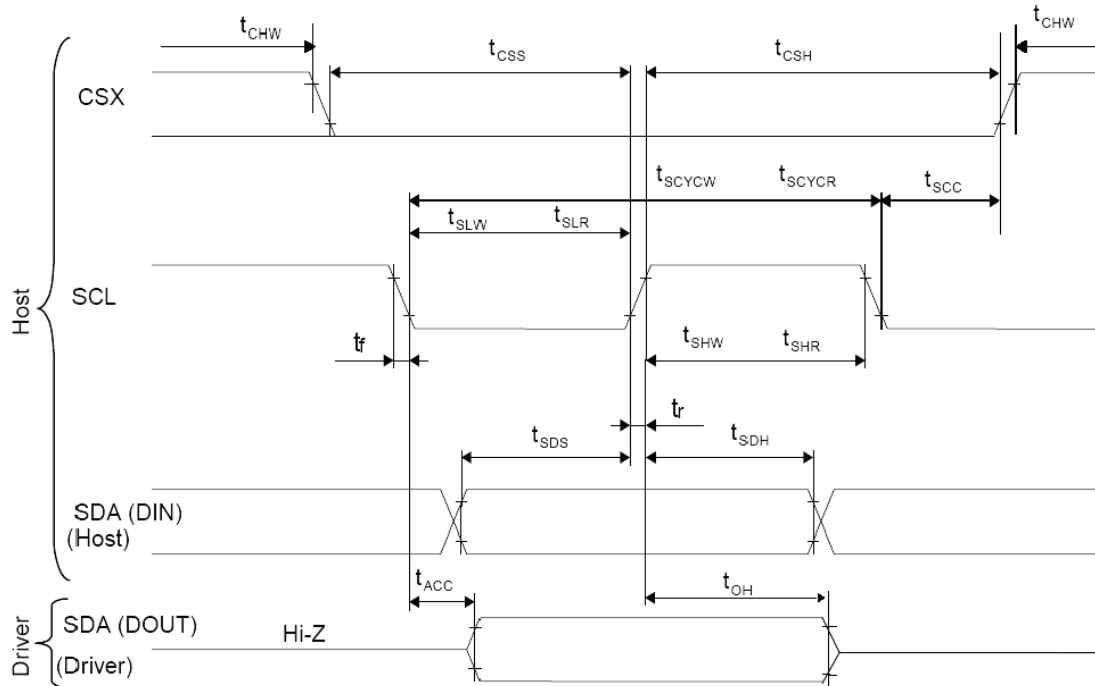
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:



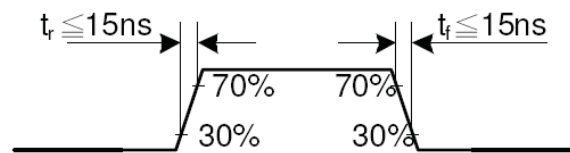
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

### 6.3 Display Serial Interface Timing Characteristics (3-line SPI system)

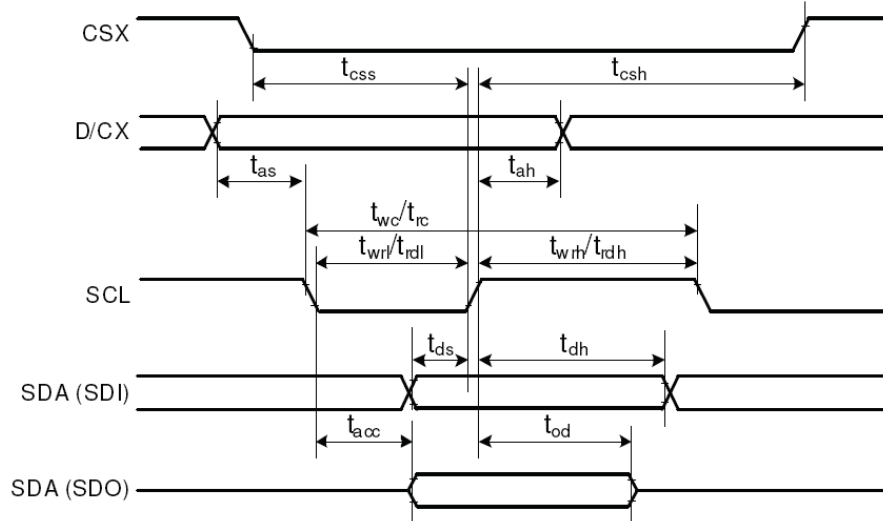


Signal	Symbol	Parameter	min	max	Unit	Description
SCL	tscycw	Serial Clock Cycle (Write)	100	-	ns	
	tshw	SCL "H" Pulse Width (Write)	40	-	ns	
	tslw	SCL "L" Pulse Width (Write)	40	-	ns	
	tscycr	Serial Clock Cycle (Read)	150	-	ns	
	tshr	SCL "H" Pulse Width (Read)	60	-	ns	
	tslr	SCL "L" Pulse Width (Read)	60	-	ns	
SDA / SDI (Input)	tsds	Data setup time (Write)	30	-	ns	
	tsdh	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	tacc	Access time (Read)	10	-	ns	
	toh	Output disable time (Read)	10	50	ns	
CSX	tsc	SCL-CSX	20	-	ns	
	tchw	CSX "H" Pulse Width	40	-	ns	
	tc	CSX-SCL Time	60	-	ns	
	tch		65	-	ns	

Note:  $T_a = 25^\circ\text{C}$ ,  $V_{DDI}=1.65\text{V to }3.3\text{V}$ ,  $V_{CI}=2.5\text{V to }3.3\text{V}$ ,  $AGND=VSS=0\text{V}$

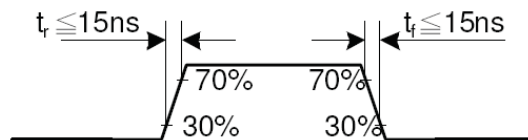


#### 6.4 Display Serial Interface Timing Characteristics (4-line SPI system)



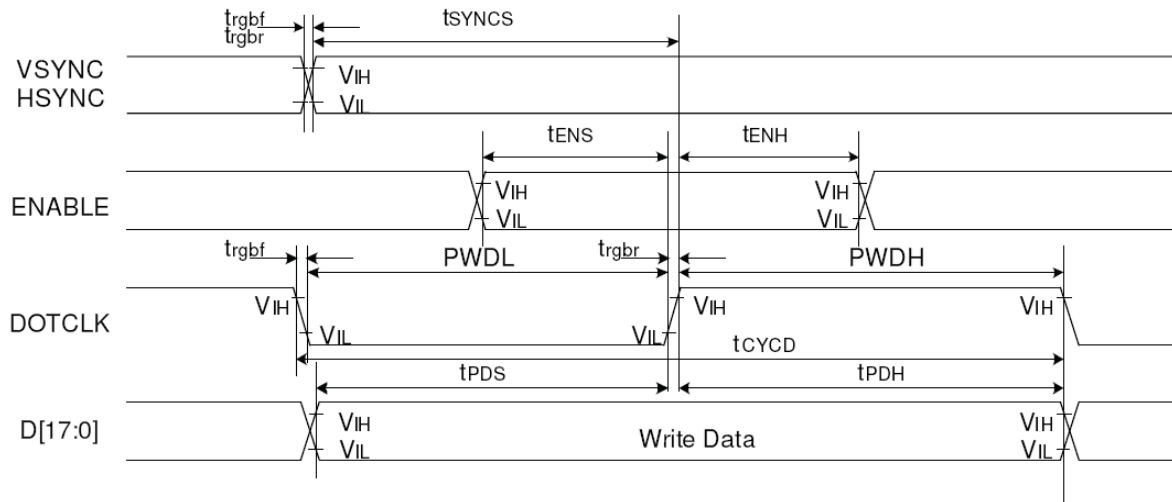
Signal	Symbol	Parameter	min	max	Unit	Description
CSX	$t_{css}$	Chip select time (Write)	40	-	ns	
	$t_{csh}$	Chip select hold time (Read)	40	-	ns	
SCL	$t_{wc}$	Serial clock cycle (Write)	100	-	ns	
	$t_{wrh}$	SCL "H" pulse width (Write)	40	-	ns	
	$t_{wrl}$	SCL "L" pulse width (Write)	40	-	ns	
	$t_{rc}$	Serial clock cycle (Read)	150	-	ns	
	$t_{rdh}$	SCL "H" pulse width (Read)	60	-	ns	
	$t_{rdl}$	SCL "L" pulse width (Read)	60	-	ns	
D/CX	$t_{as}$	D/CX setup time	10	-		
	$t_{ah}$	D/CX hold time (Write / Read)	10	-		
SDA / SDI (Input)	$t_{ds}$	Data setup time (Write)	30	-	ns	
	$t_{dh}$	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	$t_{acc}$	Access time (Read)	10	-	ns	For maximum CL=30pF
	$t_{od}$	Output disable time (Read)	10	50	ns	For minimum CL=8pF

Note:  $T_a = 25\text{ }^\circ\text{C}$ ,  $V_{DDI}=1.65\text{V to }3.3\text{V}$ ,  $V_{CI}=2.5\text{V to }3.3\text{V}$ ,  $AGND=VSS=0\text{V}$



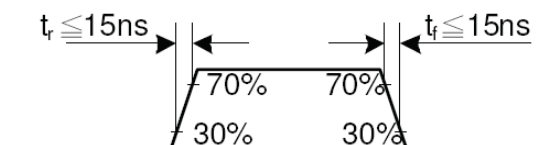


## 6.5 Parallel 18/16/6-bit RGB Interface Timing Characteristics



Signal	Symbol	Parameter	min	max	Unit	Description
VSYNC / HSYNC	$t_{SYNCS}$	VSYNC/HSYNC setup time	15	-	ns	18/16-bit bus RGB interface mode
	$t_{SYNCH}$	VSYNC/HSYNC hold time	15	-	ns	
DE	$t_{ENS}$	DE setup time	15	-	ns	
	$t_{ENH}$	DE hold time	15	-	ns	
D[17:0]	$t_{POS}$	Data setup time	15	-	ns	
	$t_{PDH}$	Data hold time	15	-	ns	
DOTCLK	PWDH	DOTCLK high-level period	15	-	ns	
	PWDL	DOTCLK low-level period	15	-	ns	
	$t_{CYCD}$	DOTCLK cycle time	100	-	ns	
	$t_{rgrbr}, t_{rgbrf}$	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	
VSYNC / HSYNC	$t_{SYNCS}$	VSYNC/HSYNC setup time	15	-	ns	6-bit bus RGB interface mode
	$t_{SYNCH}$	VSYNC/HSYNC hold time	15	-	ns	
DE	$t_{ENS}$	DE setup time	15	-	ns	
	$t_{ENH}$	DE hold time	15	-	ns	
D[17:0]	$t_{POS}$	Data setup time	15	-	ns	
	$t_{PDH}$	Data hold time	15	-	ns	
DOTCLK	PWDH	DOTCLK high-level pulse period	15	-	ns	
	PWDL	DOTCLK low-level pulse period	15	-	ns	
	$t_{CYCD}$	DOTCLK cycle time	100	-	ns	
	$t_{rgrbr}, t_{rgbrf}$	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	

Note:  $T_a = -30$  to  $70$  °C,  $V_{DDI} = 1.65V$  to  $3.3V$ ,  $V_{CI} = 2.5V$  to  $3.3V$ ,  $AGND = VSS = 0V$



## 6.6 Controller Information

IC: ILI9341

Please download IC specification at <http://www.orientdisplay.com/pdf/ILI9341.pdf>

## 7. OPTICAL CHARACTERISTICS

Item	Symbol	Conditions	Specifications	Unit	Note
Transmittance	T%	Viewing normal angle $\theta_x = \theta_y = 0^\circ$	6.0	%	All left side data are based on CMO's following condition – 1.CG : NTSC 59% 2.LC : TN 3.Light Source : CMO LED BLU 4.Film : Nitto Linear Polarizer 5.Machine : DMS
Contrast Ratio	CR		300	--	
Response Time (by Quick)	Ton+ Toff		30	ms	
Viewing Angle	Hor.	$\theta_{x+}$	60	deg.	
		$\theta_x$	60		
	Ver.	$\theta_{y+}$	60		
		$\theta_y$	50		
CF only Chromaticity	Red	$X_R$	0.631	--	Under C light Simulation
		$Y_R$	0.316	--	
	Green	$X_G$	0.298	--	
		$Y_G$	0.566	--	
	Blue	$X_B$	0.138	--	
		$Y_B$	0.122	--	
	White	$X_W$	0.297	--	
		$Y_W$	0.327	--	

\*Note (1) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

$$\text{Contrast Ratio (CR)} = L_{63} / L_0$$

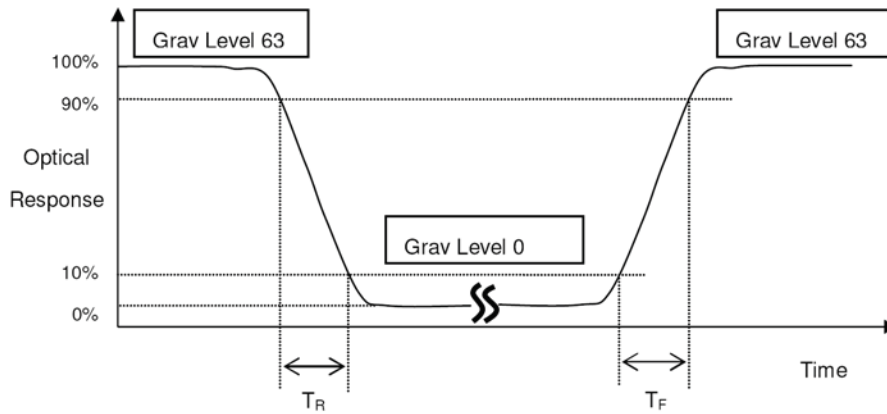
L63: Luminance of gray level 63

L 0: Luminance of gray level 0

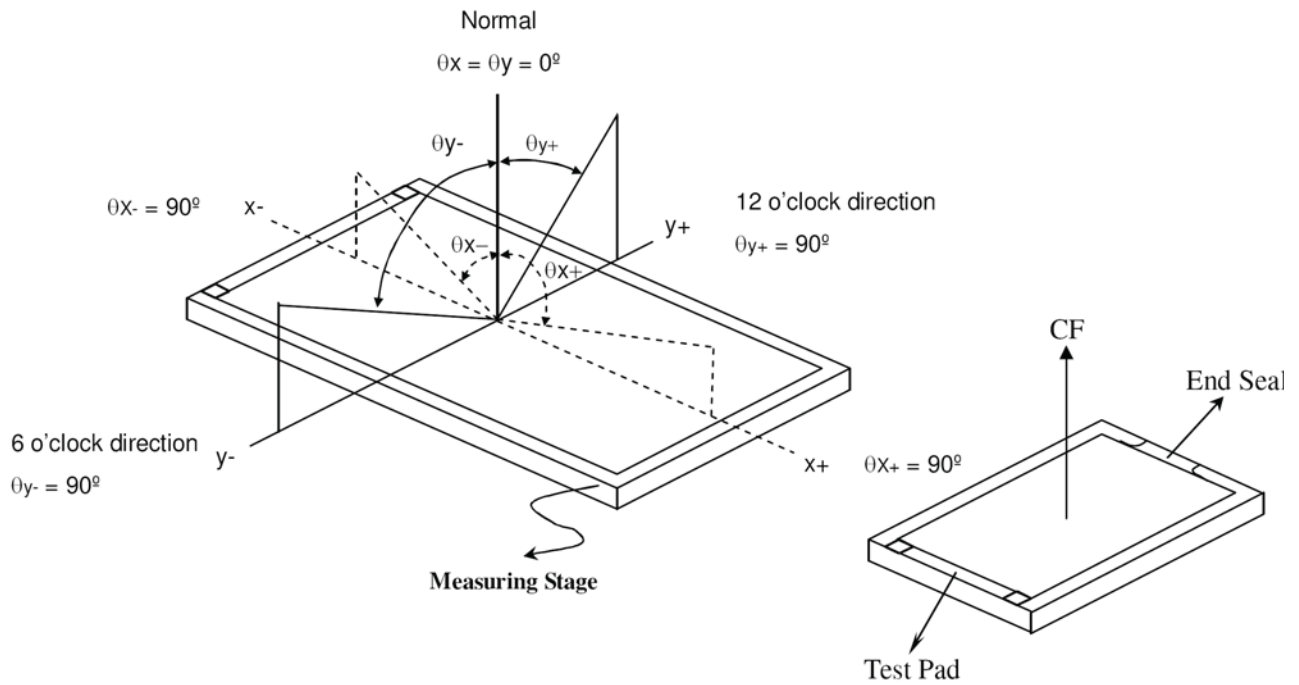
$$CR = CR (10)$$

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (5).

\*Note (2) Definition of Response Time (Ton, Toff):

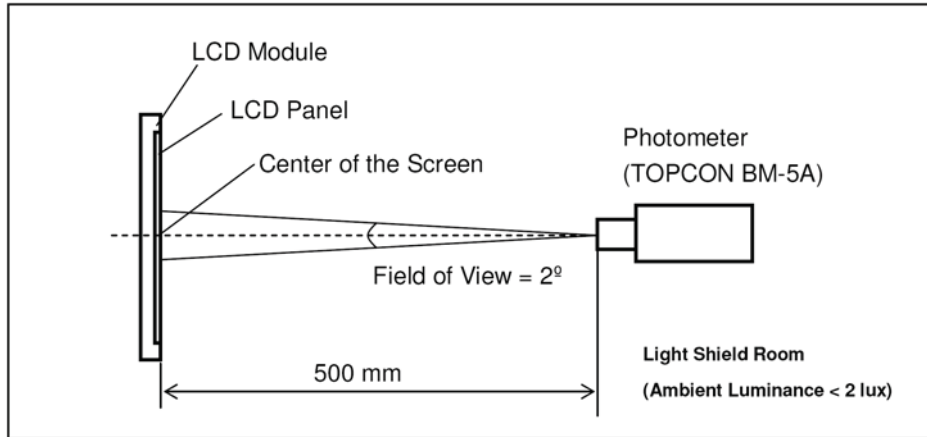


\*Note(3) Definition of Viewing Angle

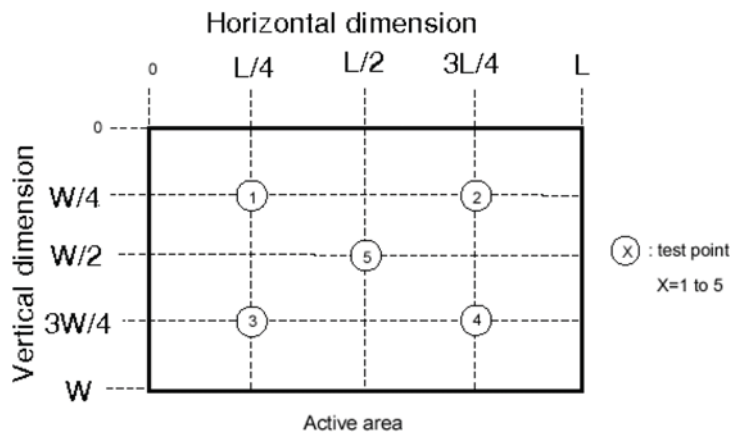


**\*Note (4) Measurement Set-Up:**

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



**Note (5)**



## **8. RELIABILITY**

Please download details at <http://www.orientdisplay.com/Reliability.html>

## **9. SPECIFICATION OF QUALITY ASSURANCE**

Please download details at <http://www.orientdisplay.com/Delivery-TFT.html>

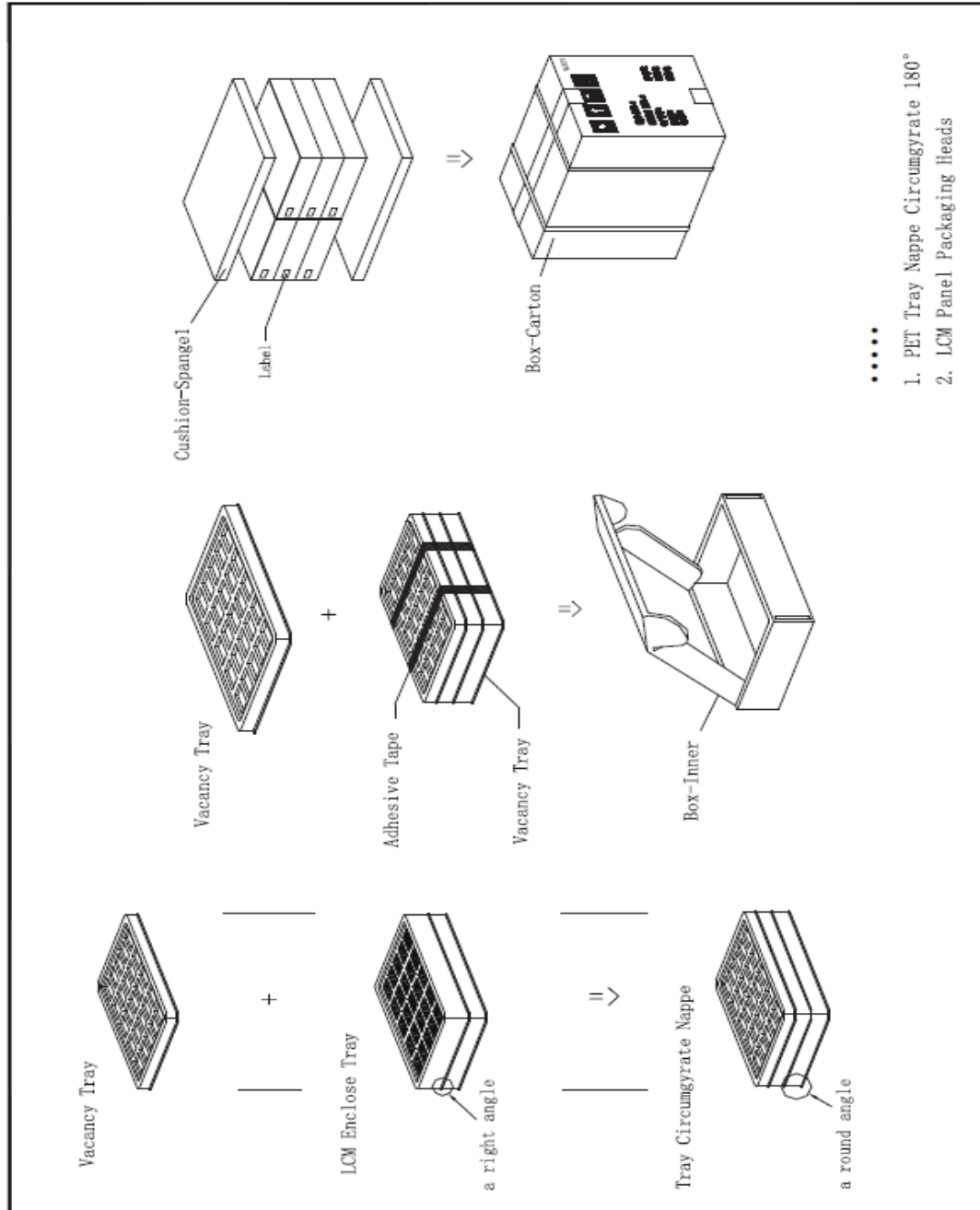
## **10. GENERAL PRECAUTIONS**

Please download details at <http://www.orientdisplay.com/General-Precautions.html>

## **11. LIMITED WARRANTY**

Please download details at <http://www.orientdisplay.com/Warranty.html>

## 12. PACKAGE



Orient Display Corporation reserves the right to change this specification.